

# Siemens Polydoros 50S/80S/100S X-ray Controls Maintenance Course

Course length: 1 Week  
CEU's Awarded: 4

<p><b>COURSE INTRODUCTION</b> The Siemens Polydoros course is designed to teach the experienced service professional those skills necessary to fully service this x-ray control. This includes complete calibration procedures, functional checks, troubleshooting and Siemens documentation interpretation. The course consists of integrated lecture, labs and documentation which complement each other ensuring the maximum learning environment.</p>	<p><b>COURSE OBJECTIVES</b> At the conclusion of this course, attendees will be able to:</p> <ul style="list-style-type: none"> <li>● Troubleshoot to the component or board level.</li> <li>● Calibrate all circuitry to the manufacturer's specification.</li> <li>● Perform all related CDRH compliance testing.</li> <li>● Verify the system performance.</li> </ul>	<p><b>PREREQUISITES FOR ADMISSION</b> Attendees must possess the knowledge acquired through attendance at our Advanced Concepts of Radiographic Imaging Maintenance-Level II course or the equivalent electronics and service experience. A strong microprocessor background is recommended.</p>
<p><b>DAY 1</b></p> <ol style="list-style-type: none"> <li>I. Introduction             <ol style="list-style-type: none"> <li>A. High frequency concepts</li> <li>B. Falling load concepts</li> <li>C. Basic operation</li> <li>D. System specifications</li> <li>E. Option packages</li> </ol> </li> <li>II. Siemens documentation             <ol style="list-style-type: none"> <li>A. Terminology/symbology</li> <li>B. Equipment layout</li> <li>C. Control panel</li> <li>D. Service board</li> <li>E. Functional diagrams</li> <li>F. Schematics</li> </ol> </li> <li>III. Console operation             <ol style="list-style-type: none"> <li>A. Knobology</li> <li>B. Anatomical programming</li> <li>C. Zero point techniques</li> </ol> </li> <li>IV. System block diagram</li> <li>V. Intermediate circuit</li> <li>VI. Power supplies</li> <li>VII. Power up sequence</li> </ol> <p><b>LAB ACTIVITIES</b></p> <ol style="list-style-type: none"> <li>I. System operation</li> <li>II. Physical layout             <ol style="list-style-type: none"> <li>A. Control console</li> <li>B. Power cabinet</li> </ol> </li> <li>III. Component location</li> <li>IV. Power supply checks/adjustments</li> <li>V. APR Programming</li> <li>VI. Troubleshooting</li> </ol>	<p><b>DAY 2</b></p> <ol style="list-style-type: none"> <li>I. KV logic diagram             <ol style="list-style-type: none"> <li>A. KV selection circuits</li> <li>B. KV inverter drive circuits</li> <li>C. KV feedback</li> <li>D. Min/Max monitoring</li> <li>E. Inverter short detection/ protection circuits</li> <li>F. Load compensation circuits</li> <li>G. Fluoro KV control</li> </ol> </li> </ol> <p><b>LAB ACTIVITIES</b></p> <ol style="list-style-type: none"> <li>I. KV circuits component location</li> <li>II. KV circuits waveform analysis</li> <li>III. KV waveform analysis</li> <li>IV. Troubleshooting</li> </ol> <p><b>DAY 3</b></p> <ol style="list-style-type: none"> <li>I. Filament control logic diagram             <ol style="list-style-type: none"> <li>A. mA selection circuits</li> <li>B. Filament inverter drive circuits</li> <li>C. Filament feedback circuits</li> <li>D. Actual value detection circuits</li> <li>E. Filament safety circuits</li> </ol> </li> <li>II. Rotor control logic diagram             <ol style="list-style-type: none"> <li>A. Rotor inverter drive circuits</li> <li>B. Start to run circuits</li> <li>C. Current sensing circuits</li> <li>D. Brake circuits</li> </ol> </li> </ol> <p><b>LAB ACTIVITIES</b></p> <ol style="list-style-type: none"> <li>I. Filament control component location</li> <li>II. Filament control calibration</li> </ol>	<ol style="list-style-type: none"> <li>A. Preheating</li> <li>B. Learning filament correction</li> <li>C. Push values</li> <li>III. Filament control waveform analysis</li> <li>IV. Rotor control programming</li> <li>V. Anode speed verification</li> <li>VI. Rotor control waveform analysis</li> <li>VII. Troubleshooting</li> </ol> <p><b>DAY 4</b></p> <ol style="list-style-type: none"> <li>I. Iontomat P logic diagram             <ol style="list-style-type: none"> <li>A. Ion chamber</li> <li>B. KV correction</li> <li>C. Density Correction</li> </ol> </li> <li>II. KK interface logic diagram             <ol style="list-style-type: none"> <li>A. Unit selection</li> <li>B. Fluoro / tomo</li> <li>C. Spotfilmer</li> <li>D. Imaging</li> </ol> </li> <li>III. Control logic             <ol style="list-style-type: none"> <li>A. MPS bus communication</li> <li>B. SMP bus communication</li> <li>C. Prep/expose logic</li> </ol> </li> </ol> <p><b>LAB ACTIVITIES</b></p> <ol style="list-style-type: none"> <li>I. AEC component locations</li> <li>II. AEC waveform analysis</li> <li>III. KV correction calibration</li> <li>IV. Density correction calibration</li> <li>V. Troubleshooting</li> </ol> <p><b>DAY 5</b></p> <ol style="list-style-type: none"> <li>I. Final exam</li> <li>II. Exam review</li> <li>III. Course critique</li> <li>IV. Parts sourcing</li> </ol>